

FEATURES

Digital gyroscope system, ±1000°/sec measurement range

In-run bias stability, 2.8°/hour

Autonomous operation and data collection

No external configuration commands required

Start-up time: 245 ms

Sleep mode recovery: 2.5 ms

Factory calibrated sensitivity and bias

Calibration temperature range: -40°C to +85°C

SPI-compatible serial interface

Wide bandwidth: 400 Hz

Embedded temperature sensor

Programmable operation and control

Automatic and manual bias correction controls

Digital filters: Bartlett FIR, average/decimation

Internal sample rate: up to 2048 SPS

Digital I/O: data ready, alarm indicator, general-purpose

Alarms for condition monitoring

Sleep mode for power management

Enable input sync operation

Single-supply operation: 4.75 V to 5.25 V

2000 g shock survivability

Operating temperature range: -40°C to +105°C

APPLICATIONS

Precision instrumentation

Platform stabilization and controls

Industrial vehicle navigation

Downhole instrumentation

Robotics

GENERAL DESCRIPTION

The **ADIS16137** *iSensor*® is a high performance, digital gyroscope sensing system that operates autonomously and requires no user configuration to produce accurate rate sensing data. It provides performance advantages with its low noise density, wide bandwidth, and excellent in-run bias stability, which enable applications such as platform control, navigation, robotics, and medical instrumentation.

This sensor system combines industry leading *iMEMS*® technology with signal conditioning that optimizes dynamic performance. The factory calibration characterizes the entire sensor signal chain for sensitivity and bias over a temperature range of -40°C to +85°C. As a result, each **ADIS16137** has its own unique correction formulas to produce accurate measurements upon installation. For some systems, the factory calibration eliminates the need for system level calibration and greatly simplifies it for others.

The **ADIS16137** provides data at rates of up to 2048 SPS and offers an averaging/decimation filter structure for optimizing noise/bandwidth trade-offs. The serial peripheral interface (SPI) and user register structure provide easy access to configuration controls and calibrated sensor data for embedded processor platforms.

The 36 mm × 44 mm × 14 mm package provides four holes for simple mechanical attachment, using M2 (or 2-56 standard size) machine screws along with a standard 24-lead, dual row, 1 mm pitch connector that supports electrical attachment to a printed circuit board (PCB) or cable system. It is package and pin compatible with the **ADIS16133**, the **ADIS16135**, and the **ADIS16136**.

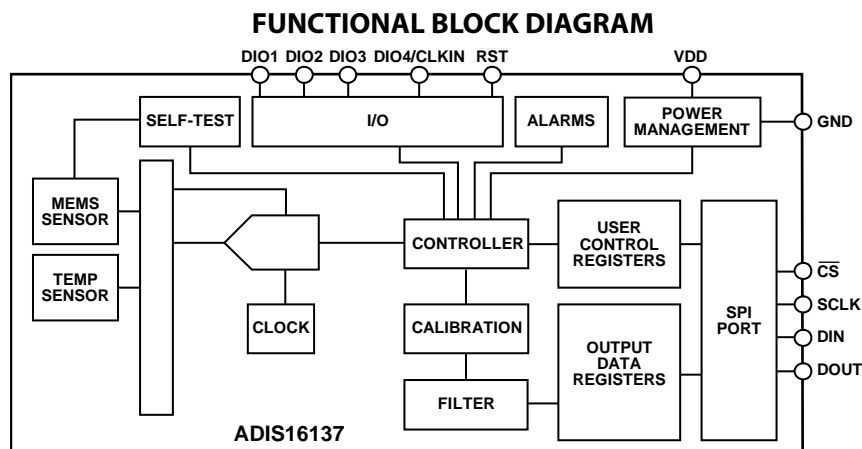


Figure 1.

Rev. A

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COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

- Breakout Board for the ADIS1613x, ADIS1637x, ADIS1648x and ADIS1649x
- EVAL-ADIS Evaluation System

DOCUMENTATION

Data Sheet

- ADIS16137: $\pm 1000^\circ/\text{Sec}$ Precision Angular Rate Sensor Data Sheet

SOFTWARE AND SYSTEMS REQUIREMENTS

- IMU Evaluation Software for the EVAL-ADISx Platforms
- USB Driver File for EVAL-ADISx Platforms (v2.2.95.68, 3/9/2016)

REFERENCE MATERIALS

Technical Articles

- Designing For Low Noise Feedback Control With Mems Gyroscopes

DESIGN RESOURCES

- ADIS16137 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all ADIS16137 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

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DOCUMENT FEEDBACK

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REVISION HISTORY

2/14—Rev. 0 to Rev. A

Changes to Figure 9	8
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10/13—Revision 0: Initial Version

SPECIFICATIONS

$T_A = 25^\circ\text{C}$, $V_{DD} = 5.0\text{ V}$, angular rate = $0^\circ/\text{sec}$, dynamic range = $\pm 1000^\circ/\text{sec}$, $\pm 1\text{ g}$, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
GYROSCOPES					
Dynamic Range		± 1000			$^\circ/\text{sec}$
Sensitivity	GYRO_OUT, GYRO_OUT2 (24 bits)		1/6300		$^\circ/\text{sec}/\text{LSB}$
Repeatability ¹	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$			± 1	%
Sensitivity Temperature Coefficient	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$, 1σ		± 40		ppm/ $^\circ\text{C}$
Nonlinearity	Best fit straight line, $\pm 500^\circ/\text{sec}$		± 0.01		% of FS
	Best fit straight line, $\pm 1000^\circ/\text{sec}$		± 0.05		% of FS
Bias Repeatability ^{1, 2}	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$, 1σ		± 0.15		$^\circ/\text{sec}$
Bias Temperature Coefficient	$-40^\circ\text{C} \leq T_A \leq +85^\circ\text{C}$, 1σ		± 0.00125		$^\circ/\text{sec}/^\circ\text{C}$
In-Run Bias Stability	25°C		2.8		$^\circ/\text{hour}$
Angular Random Walk	1σ , 25°C		0.15		$^\circ/\sqrt{\text{hour}}$
Linear Acceleration Effect on Bias	1σ		0.017		$^\circ/\text{sec}/\text{g}$
Bias Voltage Sensitivity	$V_{DD} = 4.75\text{ V}$ to 5.25 V , 1σ		± 0.08		$^\circ/\text{sec}/\text{V}$
Misalignment	Axis to frame (package)		± 1.0		Degrees
Output Noise	No filtering		0.11		$^\circ/\text{sec rms}$
Rate Noise Density	$f = 25\text{ Hz}$, no filtering		0.00357		$^\circ/\text{sec}/\sqrt{\text{Hz rms}}$
3 dB Bandwidth			400		Hz
Sensor Resonant Frequency		15.5	17.5	20	kHz
LOGIC INPUTS³					
Input High Voltage, V_{IH}		2.0			V
Input Low Voltage, V_{IL}				0.8	V
Logic 1 Input Current, I_{IH}	$V_{IH} = 3.3\text{ V}$		± 0.2	± 1	μA
Logic 0 Input Current, I_{IL}	$V_{IL} = 0\text{ V}$				
All Pins Except $\overline{\text{RST}}$			40	60	μA
$\overline{\text{RST}}$ Pin			80		μA
Input Capacitance, C_{IN}			10		pF
DIGITAL OUTPUTS³					
Output High Voltage, V_{OH}	$I_{SOURCE} = 1.6\text{ mA}$	2.4			V
Output Low Voltage, V_{OL}	$I_{SINK} = 1.6\text{ mA}$			0.4	V
FLASH MEMORY					
Data Retention ⁴	Endurance ⁴	10,000			Cycles
	$T_J = 85^\circ\text{C}$	20			Years
FUNCTIONAL TIMES⁵					
Power-On Start-Up Time	Time until data is available		245		ms
Reset Recovery Time			128		ms
Sleep Mode Recovery Time			2.5		ms
Flash Memory Update			75		ms
Flash Memory Self Test			21		ms
Automatic Sensor Self Test Time	$\text{SMPL_PRD} \neq 0x0000$		108		ms
SAMPLE RATE					
Internal Sample Rate Accuracy	$\text{SMPL_PRD} = 0x000F$	680^6		2048	SPS
Input Sync Clock Range	$\text{SMPL_PRD} = 0x0000$	680^6		± 3	%
				2048	Hz
POWER SUPPLY					
Power Supply Current	Operating voltage range (V_{DD})	4.75	5.0	5.25	V
	$\text{SMPL_PRD} = 0x000F$		120		mA
	Sleep mode		1.4		mA

¹ The repeatability specifications represent analytical projections, which are based on the following drift contributions and conditions: temperature hysteresis (-40°C to $+85^\circ\text{C}$), electronics drift (high temperature operating life test: $+85^\circ\text{C}$, 500 hours), drift from temperature cycling (JESD22-A104D, Method N, 500 cycles, -40°C to $+85^\circ\text{C}$), rate random walk (10-year projection), and broadband noise.

² Bias repeatability describes a long-term behavior, over a variety of conditions. Short-term repeatability is related to the in-run bias stability and noise density specifications.

³ The digital I/O signals are driven by an internal 3.3 V supply, and the inputs are 5 V tolerant.

⁴ JESD22-A117. Endurance measured at -40°C , $+25^\circ\text{C}$, $+85^\circ\text{C}$, and $+125^\circ\text{C}$.

⁵ These times do not include thermal settling and internal filter response times, which may affect overall accuracy.

⁶ The sync input clock and the internal sampling clock both function below the specified minimum value, at reduced performance levels.

TIMING SPECIFICATIONS

$T_A = 25^\circ\text{C}$, $V_{DD} = 5\text{ V}$, unless otherwise noted.

Table 2.

Parameter	Description	Normal Mode			Unit
		Min ¹	Typ	Max	
f_{SCLK}	Serial clock	0.01		2.5	MHz
t_{STALL}	Stall period between data, see Figure 3	15			μs
t_{READRATE}	Read rate	25			μs
t_{CS}	Chip select to clock edge	48.8			ns
t_{DAV}	DOUT valid after SCLK edge			25	ns
t_{DSU}	DIN setup time before SCLK rising edge	24.4			ns
t_{DHD}	DIN hold time after SCLK rising edge	48.8			ns
$t_{\text{SCLKR}}, t_{\text{SCLKF}}$	SCLK rise and fall times, not shown in figures		5	12.5	ns
$t_{\text{DR}}, t_{\text{DF}}$	DOUT rise and fall times, not shown in figures		5	12.5	ns
t_{SFS}	$\overline{\text{CS}}$ high after SCLK edge	0			ns
t_1	Input sync positive pulse width	5			μs
t_2	Input sync to data ready output		300		μs
t_3	Input sync period	488			μs
t_x	Input sync low time	100			μs

¹ Guaranteed by design and characterization but not tested in production.

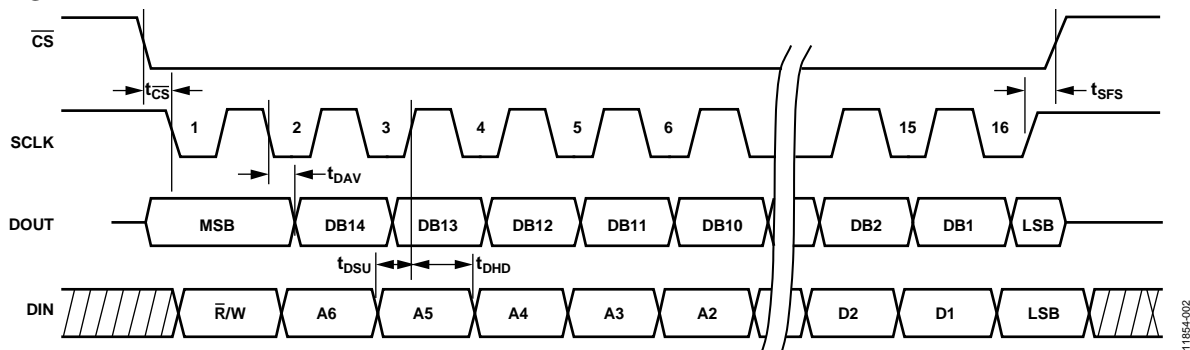
Timing Diagrams

Figure 2. SPI Timing and Sequence

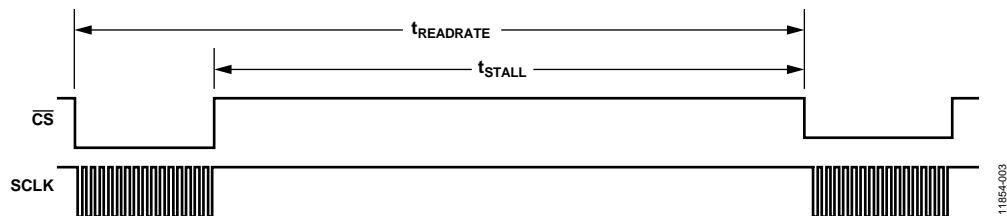


Figure 3. Stall Time and Data Rate

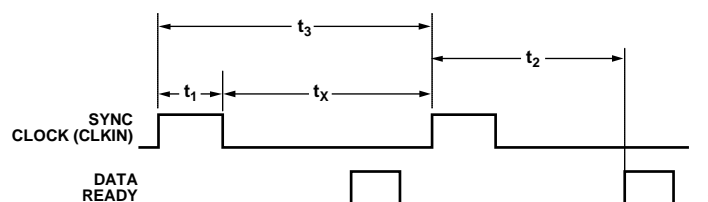


Figure 4. Input Clock Timing Diagram

ABSOLUTE MAXIMUM RATINGS**Table 3.**

Parameter	Rating
Acceleration	
Any Axis, Unpowered	2000 <i>g</i>
Any Axis, Powered	2000 <i>g</i>
VDD to GND	−0.3 V to +6.0 V
Digital Input Voltage to GND	−0.3 V to +5.3 V
Digital Output Voltage to GND	−0.3 V to VDD + 0.3 V
Operating Temperature Range	−40°C to +105°C
Storage Temperature Range	−65°C to +125°C ^{1, 2}

¹ Extended exposure to temperatures outside the specified temperature range of −40°C to +105°C can adversely affect the accuracy of the factory calibration. For best accuracy, store the devices within the specified operating temperature range of −40°C to +105°C.

² Although the device is capable of withstanding short term exposure to 150°C, long-term exposure threatens internal mechanical integrity.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

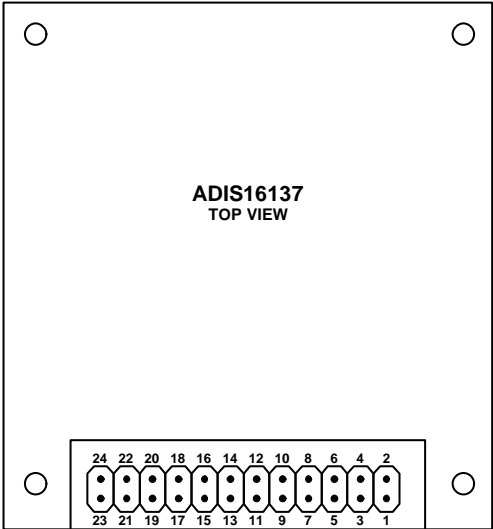
Table 4. Package Characteristics

Package Type	θ_{JA}	θ_{JC}	Device Weight
24-Lead Module with Connector Interface	15.7	1.48	31 g

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

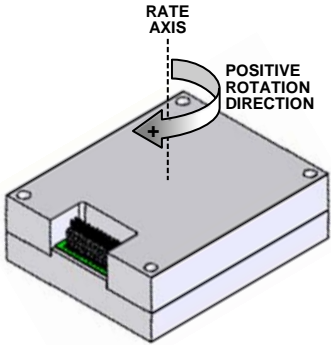
PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



- NOTES
1. PINS ARE NOT VISIBLE FROM THIS VIEW. THE PIN ASSIGNMENTS SHOWN REPRESENT THE MATING CONNECTOR ASSIGNMENTS.
 2. USE SAMTEC CLM-112-02 OR EQUIVALENT.

11854-005

Figure 5. Mating Connector Pin Assignments



11854-006

Figure 6. Axial Orientation (Bottom Side Facing Up)

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Type ¹	Description
1	DIO3	I/O	Configurable Digital Input/Output.
2	DIO4/CLKIN	I	Configurable Digital Input/Output/Clock Input.
3	SCLK	I	SPI Serial Clock.
4	DOUT	O	SPI Data Output. Clocks output on SCLK falling edge.
5	DIN	I	SPI Data Input. Clocks input on SCLK rising edge.
6	\overline{CS}	I	SPI Chip Select.
7	DIO1	I/O	Configurable Digital Input/Output.
8	\overline{RST}	I	Reset.
9	DIO2	I/O	Configurable Digital Input/Output.
10, 11, 12	VDD	S	Power Supply.
13, 14, 15	GND	S	Power Ground.
16 to 24	DNC	N/A	Do Not Connect. Do not connect to these pins.

¹ I/O is input/output, I is input, O is output, S is supply, and N/A is not applicable.

TYPICAL PERFORMANCE CHARACTERISTICS

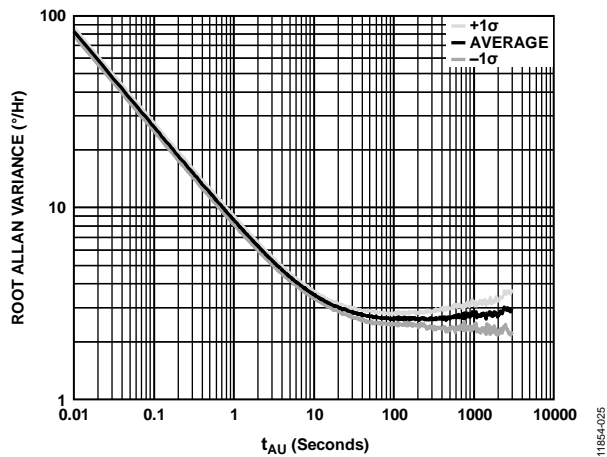
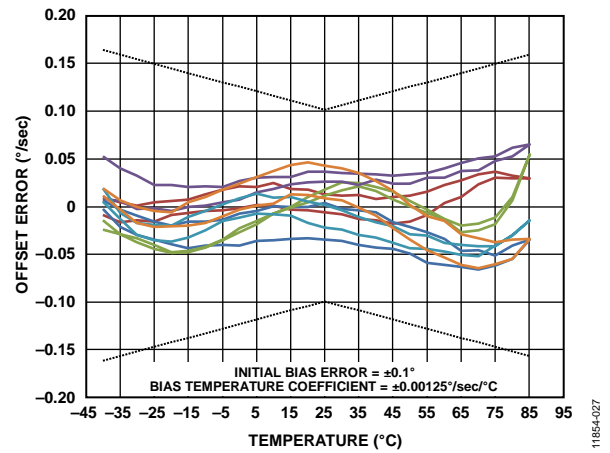
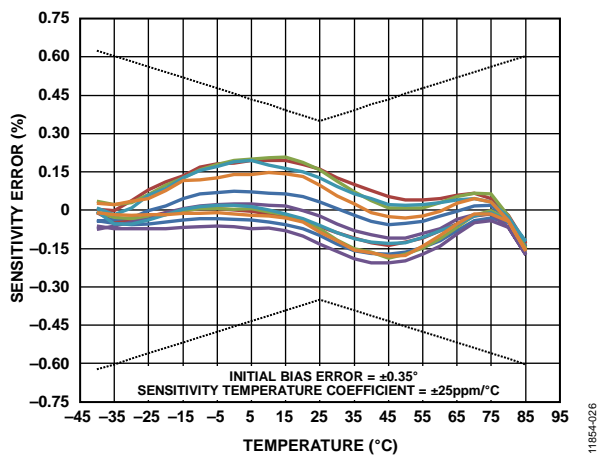


Figure 7. Root Allan Variance, 5 V, 25°C, 2048 SPS

Figure 9. Offset (Bias) Error vs. Temperature, -40°C to $+85^\circ\text{C}$ to -40°C Figure 8. Sensitivity Error vs. Temperature, -40°C to $+85^\circ\text{C}$ to -40°C

THEORY OF OPERATION

The **ADIS16137** is an autonomous system that requires no user initialization. As soon as it has a valid power supply, it initializes and starts sampling, processing, and loading sensor data into the output registers. After each sample cycle concludes, DIO1 pulses high. The SPI interface enables simple integration with many embedded processor platforms, as shown in Figure 10 (electrical connection) and Table 6 (processor pin names and functions).

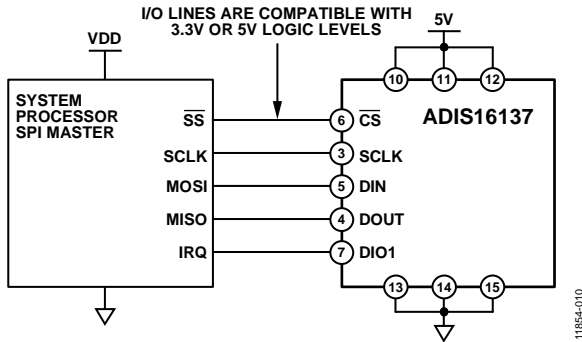


Figure 10. Electrical Connection Diagram

Table 6. Generic Master Processor Pin Names and Functions

Pin Name	Function
SS	Slave select
SCLK	Serial clock
MOSI	Master output, slave input
MISO	Master input, slave output
IRQ	Interrupt request

The **ADIS16137** SPI interface supports full duplex serial communication (simultaneous transmit and receive) and uses the bit sequence shown in Figure 13. Table 7 provides a list of the most common settings that require attention to initialize a processor serial port for the **ADIS16137** SPI interface.

Table 7. Generic Master Processor SPI Settings

Processor Setting	Description
Master	ADIS16137 operates as a slave
SCLK Rate ≤ 2.5 MHz	Maximum serial clock rate
SPI Mode 3	CPOL = 1 (polarity), CPHA = 1 (phase)
MSB First Mode	Bit sequence
16-Bit Mode	Shift register/data length

READING SENSOR DATA

A single register read requires two 16-bit SPI cycles. The first cycle requests the contents of a register using the bit assignments shown in Figure 13. Then, the register contents follow on DOUT during the second sequence. Figure 11 includes three single register reads in succession. In this example, the process starts with Pin 5, DIN = 0x0600, to request the contents of the GYRO_OUT register and follows with 0x0400 to request the contents of the GYRO_OUT2 register and then with 0x0200 to request the contents of the TEMP_OUT register. Full duplex operation enables processors to use the same 16-bit SPI cycle to read data from DOUT while requesting the next set of data on the DIN pin. Figure 12 provides an example of the four SPI signals when reading GYRO_OUT in a repeating pattern.



Figure 11. SPI Read Example

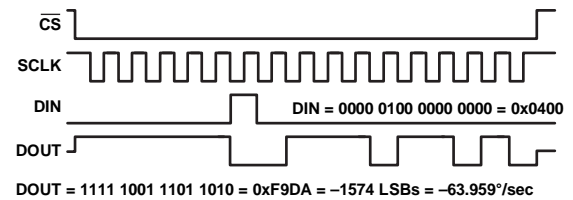
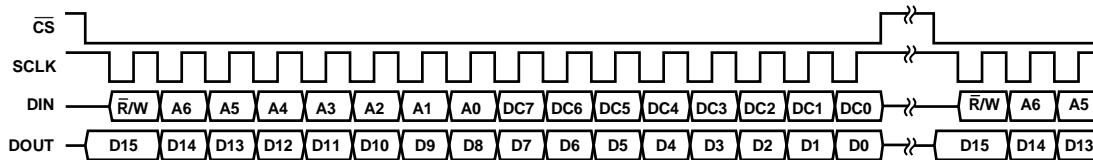


Figure 12. SPI Read Example, Second 16-Bit Sequence



NOTES

1. DOUT BITS ARE PRODUCED ONLY WHEN THE PREVIOUS 16-BIT DIN SEQUENCE STARTS WITH R/W = 0.
2. WHEN CS IS HIGH, DOUT IS IN A THREE-STATE, HIGH IMPEDANCE MODE, WHICH ALLOWS MULTIFUNCTIONAL USE OF THE LINE FOR OTHER DEVICES.

Figure 13. SPI Communication Bit Sequence

OUTPUT DATA REGISTERS

Table 8. Output Data Register Formats

Register	Address	Measurement
TEMP_OUT	0x02	Internal temperature
GYRO_OUT2	0x04	Gyroscope, lower 16 bits
GYRO_OUT	0x06	Gyroscope, upper 16 bits

Rotation Rate (Gyroscope)

GYRO_OUT is the primary register for gyroscope output data and uses 16-bit twos complement format for its data. Table 9 provides the numerical format, and Table 10 provides several examples for converting digital data into °/sec.

Table 9. GYRO_OUT Bit Descriptions

Bits	Description
[15:0]	Gyroscope data; twos complement, 256°/sec per 6300 LSB, 0°/sec = 0x0000

Table 10. GYRO_OUT, Twos Complement Format

Rotation Rate (°/sec)	Decimal	Hex	Binary
+1000	+24,609	0x6021	0110 0000 0010 0001
+512 ÷ 6300	+2	0x0002	0000 0000 0000 0010
+256 ÷ 6300	+1	0x0001	0000 0000 0000 0001
0	0	0x0000	0000 0000 0000 0000
−256 ÷ 6300	−1	0xFFFF	1111 1111 1111 1111
−512 ÷ 6300	−2	0xFFFE	1111 1111 1111 1110
−1000	−24,609	0x9FDF	1001 1111 1101 1111

The GYRO_OUT2 register (see Table 11) captures the bit growth associated with the decimation and FIR filters (see Figure 18) using an MSB justified format. The bit growth starts with the MSB (GYRO_OUT2[15]), is equal to the decimation rate setting in DEC_RATE[4:0] (see Table 18), and grows in the LSB direction as the decimation rate increases. See Figure 14 for more details.

Table 11. GYRO_OUT2 Bit Descriptions

Bits	Description
[15:0]	Rotation rate data; resolution enhancement bits

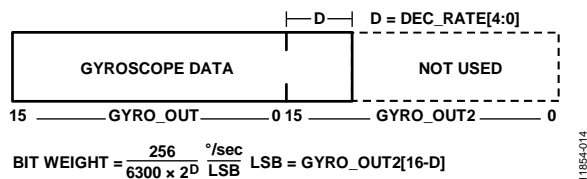


Figure 14. Gyroscope Output Format, DEC_RATE[4:0] > 0

Internal Temperature

The TEMP_OUT register (see Table 12) provides an internal temperature measurement for observing relative temperature changes in the environment. Table 13 provides several coding examples for converting the 16-bit twos complement number into units for temperature (°C).

Table 12. TEMP_OUT Bit Descriptions

Bits	Description
[15:0]	Temperature data; twos complement, 0.010697°C per LSB, 0°C = 0x0000

Table 13. Temperature, Twos Complement Format

Temperature	Decimal	Hex	Binary
+85°C	+7946	0x1F0A	0001 1111 0000 1010
+0.021394°C	+2	0x0002	0000 0000 0000 0010
+0.010697°C	+1	0x0001	0000 0000 0000 0001
0°C	0	0x0000	0000 0000 0000 0000
−0.010697°C	−1	0xFFFF	1111 1111 1111 1111
−0.021394°C	−2	0xFFFE	1111 1111 1111 1110
−40°C	−3739	0xF165	1111 0001 0110 0101

DEVICE CONFIGURATION

The control registers in Table 14 list a variety of user configuration options. The SPI provides access to these registers, one byte at a time, using the bit assignments shown in Figure 13. Each register has 16 bits, wherein Bits[7:0] represent the lower address, and Bits[15:8] represent the upper address.

Figure 15 provides an example of writing 0x03 to Address 0x22 (DEC_RATE[7:0]), using DIN = 0xA203. This example reduces the sample rate by a factor of 8 (see Table 18).

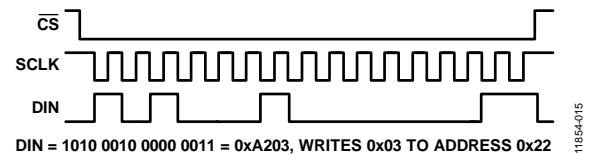


Figure 15. SPI Sequence for Setting the Decimate Rate to 8 (DIN = 0xA203)

Dual Memory Structure

Writing configuration data to a control register updates its SRAM contents, which are volatile. After optimizing each relevant control register setting in a system, set GLOB_CMD[3] = 1 (DIN = 0xA808) to backup these settings in the nonvolatile flash memory. The flash backup process requires a valid power supply level for the entire processing time (see Table 1). Table 14 provides a user accessible, register memory map that includes a column to identify the registers that are nonvolatile, through the flash memory backup. A yes in this column indicates that a register has a mirror location in flash and, when backed up properly, automatically restores itself during startup or after a reset. Figure 16 provides a diagram of the dual memory structure that manages operation and stores critical user settings.

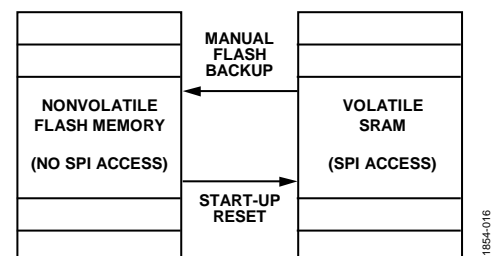


Figure 16. SRAM and Flash Memory Diagram

USER REGISTERS

Table 14. User Register Memory Map

Name	R/W	Flash Backup	Address ¹	Default	Register Description	Bit Descriptions
FLASH_CNT	R	Yes	0x00	N/A ²	Flash memory write count	Table 30
TEMP_OUT	R	No	0x02	N/A ²	Output, temperature (internal)	Table 12
GYRO_OUT2	R	No	0x04	N/A ²	Output, gyroscope, lower 16 bits	Table 11
GYRO_OUT	R	No	0x06	N/A ²	Output, gyroscope, upper 16 bits	Table 9
GYRO_OFF2	R/W	Yes	0x08	0x0000	Gyroscope bias correction, lower 16 bits	Table 21
GYRO_OFF	R/W	Yes	0x0A	0x0000	Gyroscope bias correction, upper 16 bits	Table 20
Reserved	N/A ²	N/A ²	0x0C to 0x0F	N/A ²	Reserved	
ALM_MAG1	R/W	Yes	0x10	0x0000	Alarm 1 trigger level setting	Table 23
ALM_MAG2	R/W	Yes	0x12	0x0000	Alarm 2 trigger level setting	Table 24
ALM_SMPL1	R/W	Yes	0x14	0x0000	Alarm 1 sample period	Table 25
ALM_SMPL2	R/W	Yes	0x16	0x0000	Alarm 2 sample period	Table 25
ALM_CTRL	R/W	Yes	0x18	0x0000	Alarm configuration	Table 26
GPIO_CTRL	R/W	Yes	0x1A	0x0000	Auxiliary digital input/output control	Table 32
MSC_CTRL	R/W	Yes	0x1C	0x0006	Data ready, self-test, calibration, misc. control	Table 31
SMPL_PRD	R/W	Yes	0x1E	0x000F	Internal sample period (rate) control	Table 16
AVG_CNT	R/W	Yes	0x20	0x0000	Digital filter control	Table 17
DEC_RATE	R/W	Yes	0x22	0x0000	Decimation rate setting	Table 18
SLP_CTRL	W	Yes	0x24	N/A ²	Sleep mode control	Table 33
DIAG_STAT	R	No	0x26	0x0000	System status/error flags	Table 34
GLOB_CMD	W	No	0x28	0x0000	System commands	Table 29
Reserved	N/A ²	N/A ²	0x2A to 0x31	N/A ²	Reserved	
LOT_ID1	R	Yes	0x32	N/A ²	Lot Identification Code 1	Table 36
LOT_ID2	R	Yes	0x34	N/A ²	Lot Identification Code 2	Table 36
LOT_ID3	R	Yes	0x36	N/A ²	Lot Identification Code 3	Table 36
PROD_ID	R	Yes	0x38	0x3F09	Product identification, binary number for 16,137	Table 35
SERIAL_NUM	R	Yes	0x3A	N/A ²	Serial number	Table 37

¹ Each register contains two bytes. The address column in this table only offers the address of the lower byte; add 1 to it to calculate the address of the upper byte.

² N/A means not applicable.

DIGITAL PROCESSING CONFIGURATION

Figure 18 provides a block diagram for the sampling and digital filter stages inside of the ADIS16137. Table 15 provides a summary of registers for sample rate and filter control.

Table 15. Digital Processing Registers

Register Name	Address	Description
SMPL_PRD	0x1E	Internal sample period (rate) control
AVG_CNT	0x20	Digital filter control
DEC_RATE	0x22	Decimation rate setting

INTERNAL SAMPLE RATE

The SMPL_PRD register in Table 16 provides a programmable control for the internal sample rate. Use the following formula to calculate the decimal number for the code to write into this register:

$$SMPL_PRD = \frac{32,768}{f_s} - 1; f_s \leq 2048 \text{ SPS}$$

The factory default setting for SMPL_PRD sets the internal sample rate to a rate of 2048 SPS; the minimum setting for the SMPL_PRD register is 0x000F, which results in an internal sample rate of 2048 SPS. Note that optimal performance often requires the maximum sample rate.

Table 16. SMPL_PRD Bit Descriptions

Bits	Description (Default = 0x000F)
[15:0]	Clock setting bits; sets f_s in Figure 18

INPUT CLOCK CONFIGURATION

Set SMPL_PRD = 0x0000 (DIN = 0x9F00, then DIN = 0x9E00) to disable the internal clock and enable DIO4/CLKIN as a clock input pin.

DIGITAL FILTERING

The AVG_CNT register (see Table 17) provides user controls for the low-pass filter. This filter contains two cascaded averaging filters that provide a Bartlett window FIR filter response (see Figure 17). For example, set AVG_CNT[7:0] = 0x04 (DIN = 0xA004) to set each stage to 16 taps. When used with the default sample rate of 2048 SPS, this establishes a -3 dB bandwidth of approximately 48 Hz for this filter.

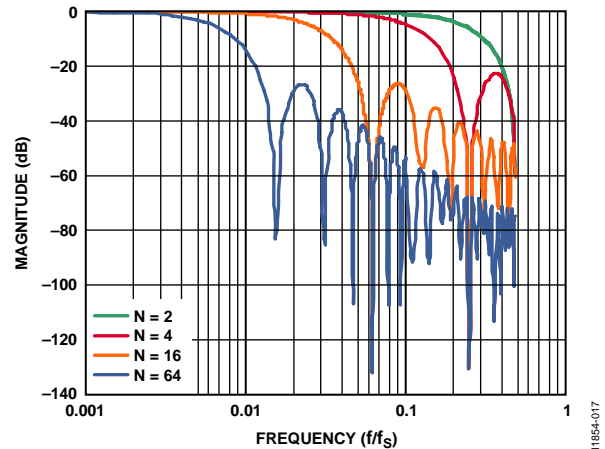


Figure 17. Bartlett Window FIR Filter Frequency Response

Table 17. AVG_CNT Bit Descriptions

Bits	Description (Default = 0x0000)
[15:3]	Don't care
[2:0]	Binary; B variable in Figure 18; maximum = 110 (6)

AVERAGING/DECIMATION FILTER

The DEC_RATE register (see Table 18) provides user control for the final filter stage (see Figure 18), which averages and decimates the output data. For systems that value lower sample rates, this filter stage provides an opportunity to lower the sample rate while maintaining optimal bias stability performance. The -3 dB bandwidth of this filter stage is approximately one-half of the output data rate. For example, set DEC_RATE[7:0] = 0x04 (DIN = 0xA204) to reduce the sample rate by a factor of 16. When the factory default 2048 SPS sample rate is used, this decimation setting reduces the output data rate to 128 SPS and the sensor bandwidth to approximately 64 Hz.

Table 18. DEC_RATE Bit Descriptions

Bits	Description (Default = 0x0000)
[15:5]	Don't care
[4:0]	Binary; D variable in Figure 18; maximum = 10000 (binary) = 16 (decimal)

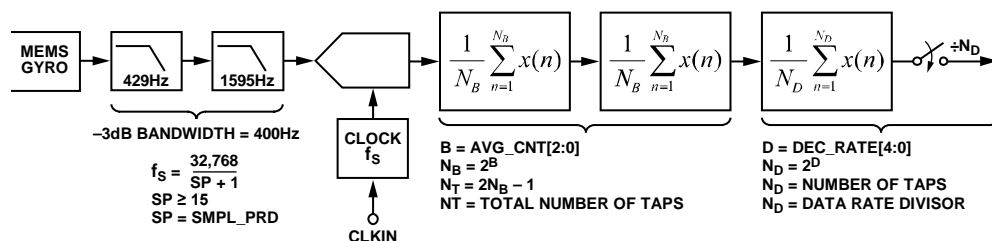


Figure 18. Sampling and Frequency Response Block Diagram

CALIBRATION

The [ADIS16137](#) factory calibration produces correction formulas for the gyroscope and programs them into the flash memory. Table 19 contains a list of user control registers that provide an opportunity for user optimization after installation. Figure 19 illustrates the summing function of the sensor's offset correction register.

Table 19. Registers for User Calibration

Register	Address	Description
GYRO_OFF2	0x08	Gyroscope bias, lower 16 bits
GYRO_OFF	0x0A	Gyroscope bias, upper 16 bits
GLOB_CMD	0x28	Bias correction command

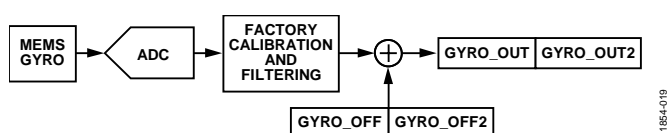


Figure 19. Gyroscope Bias Calibration User Controls

The factory calibration addresses initial and temperature dependent bias errors in the gyroscopes, but some environmental conditions, such as temperature cycling and mechanical stress on the package, can cause bias shifts in MEMS gyroscope structures. For systems that value absolute bias accuracy, there are two options for optimizing absolute bias accuracy: autonull and manual correction.

AUTOMATIC BIAS CORRECTION (AUTONULL)

Set `GLOB_CMD[0] = 1` (`DIN = 0xA801`) to start the automatic bias correction (ABC) function, which uses the following internal sequence to calibrate each gyroscope for bias error:

1. Wait for a complete output data cycle to complete, which includes the entire average and decimation time in `DEC_RATE`.
2. Read the output registers of the gyroscope.
3. Multiply the measurement by -1 to change its polarity.
4. Write the final value into the offset registers.
5. Update the flash memory.

The Allan variance curve (see Figure 7) provides a trade-off between bias accuracy and averaging time, and the `DEC_RATE` register provides a user control for averaging time when using the ABC function. For example, set `DEC_RATE[7:0] = 0x10` (`DIN = 0xA210`), which sets the decimation rate to 65,536 (2^{16}) and provides an averaging time of 32 seconds ($65,536 \div 2048$ SPS) for this function. Next, set `GLOB_CMD[0] = 1` (`DIN = 0xA801`), and keep the platform stable for this time period while the gyroscope bias data accumulates.

When the ABC function starts, the SPI is not active. The only way to interrupt the ABC function is to remove power or initiate a hardware reset using the `RST` pin. See Table 29 for more information on `GLOB_CMD`.

MANUAL BIAS CORRECTION

The `GYRO_OFF` and `GYRO_OFF2` registers (see Table 20 and Table 21) provide a bias adjustment function for the output of each sensor. `GYRO_OFF` has the same format as `GYRO_OUT` (see Table 10), and `GYRO_OFF2` has the same format as `GYRO_OUT2` (see Table 11 and Figure 14).

Table 20. GYRO_OFF Bit Descriptions

Bits	Description (Default = 0x0000)
[15:0]	Gyroscope bias correction; twos complement, $256^\circ/\text{sec}$ per 6300 LSB, $0^\circ/\text{sec} = 0x0000$

Table 21. GYRO_OFF2 Bit Descriptions

Bits	Description (Default = 0x0000)
[15:0]	Gyroscope bias correction; resolution enhancement bits

RESTORING FACTORY CALIBRATION

Set `GLOB_CMD[1] = 1` (`DIN = 0xA802`) to execute the factory calibration restore function. This function resets each user calibration register to 0x0000, resets all sensor data to 0, and automatically updates the flash memory. See Table 29 for more information on `GLOB_CMD`.

ALARMS

The alarm function provides monitoring for two independent conditions. Table 22 contains a list of registers that provide configuration and control inputs for the alarm function.

Table 22. Registers for Alarm Configuration

Register	Address	Description
ALM_MAG1	0x10	Alarm 1, trigger level setting
ALM_MAG2	0x12	Alarm 2, trigger level setting
ALM_SMPL1	0x14	Alarm 1, sample period
ALM_SMPL2	0x16	Alarm 2, sample period
ALM_CTRL	0x18	Alarm configuration

The ALM_CTRL register (see Table 26) provides data source selection (Bits[15:8]), static/dynamic setting for each alarm (Bits[7:6]), trigger polarity (Bits[5:4]), data source filtering (Bit 3), and an alarm indicator signal (Bits[2:0]).

STATIC ALARM USE

The static alarm settings compare the data source selection (ALM_CTRL[15:8]) with the values in the ALM_MAGx registers in Table 23 and Table 24. The data format in these registers matches the format of the data selection in ALM_CTRL[15:8]. ALM_CTRL[5:4] provide polarity settings. See Table 27 for a static alarm configuration example.

Table 23. ALM_MAG1 Bit Descriptions

Bits	Description (Default = 0x0000)
[15:0]	Threshold setting; matches format of the ALM_CTRL[11:8] selection

Table 24. ALM_MAG2 Bit Descriptions

Bits	Description (Default = 0x0000)
[15:0]	Threshold setting; matches for format of the ALM_CTRL[15:12] selection

DYNAMIC ALARM USE

The dynamic alarm setting monitors the data selection for a rate-of-change comparison. The rate of change is represented by the magnitude in the ALM_MAGx registers over the time represented by the number of samples in the ALM_SMPLx register (see Table 25). See Table 27 for a dynamic alarm configuration example.

Table 25. ALM_SMPL1, ALM_SMPL2 Bit Descriptions

Bits	Description (Default = 0x0000)
[15:8]	Not used
[7:0]	Binary, number of samples (both 0x00 and 0x01 = 1)

ALARM REPORTING

DIAG_STAT[9:8] provide error flags that indicate an alarm condition (see Table 34). ALM_CTRL[2:0] provide controls for a hardware indicator using DIO1 or DIO2.

Table 26. ALM_CTRL Bit Descriptions

Bits	Description (Default = 0x0000)
[15:12]	Alarm 2 source selection 0000 = disable 0001 = GYRO_OUT (does not include GYRO_OUT2) 0010 = TEMP_OUT 0011 = DIAG_STAT
[11:8]	Alarm 1 source selection (same as Alarm 2)
7	Rate-of-change enable for Alarm 2 (1 = rate of change, 0 = static level)
6	Rate-of-change enable for Alarm 1 (1 = rate of change, 0 = static level)
5	Comparison polarity for Alarm 2 (1 specifies > ALM_MAG2, 0 specifies < ALM_MAG2)
4	Comparison polarity for Alarm 1 (1 specifies > ALM_MAG1, 0 specifies < ALM_MAG1)
3	Comparison data filter setting ¹ (1 = Bartlett filter, 0 = no filtering)
2	Alarm output enable (1 = enabled, 0 = disabled)
1	Alarm output polarity (1 = active high, 0 = active low)
0	Alarm output line select (1 = DIO2, 0 = DIO1)

¹ Filtering applies to GYRO_OUT only.

Alarm Example

Table 27 offers an example that configures Alarm 1 to trigger when filtered GYRO_OUT data drops below 50°/sec and Alarm 2 to trigger when filtered GYRO_OUT data changes by more than 50°/sec over a 49.8 ms period, or ~1004°/sec². The filter setting helps reduce false triggers from noise and refine the accuracy of the trigger points. The ALM_SMPL2 setting of 102 samples provides a comparison period that is 49.8 ms for an internal sample rate of 2048 SPS. There is no need to program ALM_SMPL1 because Alarm 1 is a static alarm in this example.

Table 27. Alarm Configuration Example 1

DIN	Description
0x9911, 0x98AF	ALM_CTRL = 0x11AF Alarm 2: dynamic; ΔGYRO_OUT (Δtime, ALM_SMPL2) > ALM_MAG2 Alarm 1: static; GYRO_OUT < ALM_MAG1; use filtered data source for comparison; DIO2 output indicator, positive polarity
0x9304, 0x92CE	ALM_MAG2 = 0x04CE, 50°/sec
0x9104, 0x90CE	ALM_MAG1 = 0x04CE, 50°/sec
0x9666	ALM_SMPL2[7:0] = 0x66, 102 samples

SYSTEM CONTROLS

Table 28 lists the registers associated with a number of system level controls for managing its operation.

Table 28. System Tool Registers

Register Name	Address	Description
GPIO_CTRL	0x1A	General-purpose I/O control
MSC_CTRL	0x1C	Data ready, self test, calibration, miscellaneous control
SLP_CTRL	0x24	Sleep mode control
DIAG_STAT	0x26	System status/error flags
GLOB_CMD	0x28	System commands
LOT_ID1	0x32	Lot Identification Code 1
LOT_ID2	0x34	Lot Identification Code 2
LOT_ID3	0x36	Lot Identification Code 3
PROD_ID	0x38	Product identification
SERIAL_NUM	0x3A	Serial number

GLOBAL COMMANDS

The GLOB_CMD register (see Table 29) provides trigger bits for several operations. Write 1 to the appropriate bit in GLOB_CMD to start a function. After the function completes, the bit restores to zero.

Software Reset

Set GLOB_CMD[7] = 1 (DIN = 0xA880) to reset the operation, which removes all data, initializes all registers from their flash settings, and starts data collection. This function provides a firmware alternative to the RST line (see Table 5, Pin 8).

Table 29. GLOB_CMD Bit Descriptions

Bits	Description (Default = 0x0000)
[15:8]	Not used
7	Software reset
[6:4]	Not used
3	Flash update
2	Not used
1	Factory calibration restore
0	Automatic bias correction

MEMORY MANAGEMENT

The data retention of the flash memory depends on the temperature, as shown in Figure 20. The FLASH_CNT register (see Table 30) provides a 16-bit counter that helps track the number of write cycles to the nonvolatile flash memory, which helps the user manage against the endurance rating. The flash updates every time any of the following bits are set to 1: GLOB_CMD[3], GLOB_CMD[1], and GLOB_CMD[0].

Table 30. FLASH_CNT Bit Descriptions

Bits	Description
[15:0]	Binary counter; number of flash updates

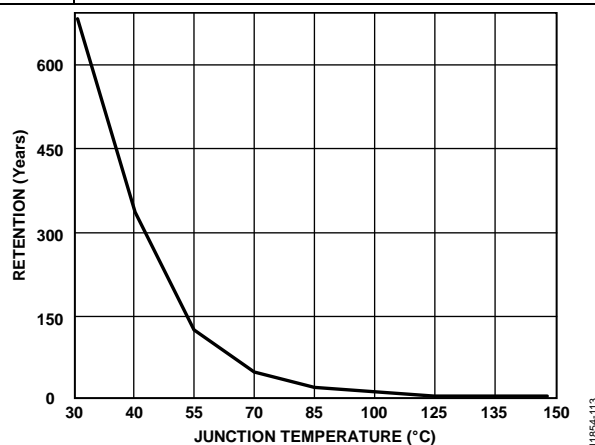


Figure 20. Flash Memory Retention

Checksum Test

Set MSC_CTRL[11] = 1 (DIN = 0x9D08) to perform a checksum verification of the internal program memory. This takes a summation of the internal program memory and compares it with the original summation value for the same locations (from factory configuration). Check the results in the DIAG_STAT register (see Table 34). DIAG_STAT[6] = 0 if the sum matches the correct value and 1 if it does not. Ensure that the power supply is within specification for the entire processing time for this function (see Table 1).

GENERAL-PURPOSE INPUT/OUTPUT

Four general-purpose I/O lines (DIO1, DIO2, DIO3, and DIO4/CLKIN) provide a number of useful functions. The MSC_CTRL[2:0] bits (see Table 31) control the data ready configuration and have the highest priority for setting either DIO1 or DIO2 (but not both). The ALM_CTRL[2:0] control bits (see Table 26) provide the alarm indicator configuration control and have the second highest priority for DIO1 or DIO2. When DIO1 and DIO2 are not in use as either data ready or alarm indicator signals, the GPIO_CTRL register (see Table 32) provides the control and data bits for them, together with the DIO3 and DIO4 lines.

Table 31. MSC_CTRL Bit Descriptions

Bits	Description (Default = 0x0006)
[15:12]	Not used
11	Memory test; cleared upon completion (1 = enabled, 0 = disabled)
10	Automatic self test; cleared upon completion (1 = enabled, 0 = disabled)
[9:8]	Do not use, always set both bits to zero.
7	Disable sensor compensation (1 = disable compensation, 0 = enable compensation)
[6:3]	Not used
2	Data ready enable (1 = enabled, 0 = disabled)
1	Data ready polarity (1 = active high, 0 = active low)
0	Data ready line select (1 = DIO2, 0 = DIO1)

Table 32. GPIO_CTRL Bit Descriptions

Bits	Description (Default = 0x0000)
[15:12]	Don't care
11	General-Purpose I/O Line 4 (DIO4) data level
10	General-Purpose I/O Line 3 (DIO3) data level
9	General-Purpose I/O Line 2 (DIO2) data level
8	General-Purpose I/O Line 1 (DIO1) data level
[7:4]	Don't care
3	General-Purpose I/O Line 2 (DIO2) direction control (1 = output, 0 = input)
2	General-Purpose I/O Line 1 (DIO1) direction control (1 = output, 0 = input)
1	General-Purpose I/O Line 2 (DIO2) direction control (1 = output, 0 = input)
0	General-Purpose I/O Line 1 (DIO1) direction control (1 = output, 0 = input)

Data Ready Input/Output Indicator

The factory default setting for MSC_CTRL[2:0] is 110, which configures DIO1 as a positive data ready indicator signal. A common option for this function is MSC_CTRL[2:0] = 100 (DIN = 0x9C04), which changes data ready to a negative polarity for processors that provide only negative triggered interrupt pins. The pulse width is between 100 µs and 200 µs over all conditions.

Example Input/Output Configuration

For example, set GPIO_CTRL[7:0] = 0x02 (DIN = 0x9A02) to set DIO1 as an input and DIO2 as an output. Then, set GPIO_CTRL[15:8] = 0x02 (DIN = 0x9B02) to set DIO2 in a high output state. Monitor DIO1 by reading GPIO_CTRL[8] (DIN = 0x1B00).

AUTOMATIC SELF TEST

The MSC_CTRL bits (see Table 31) provide an automatic self test function that helps verify the mechanical integrity of the MEMS structure, together with the basic function of the signal processing circuit. When enabled, the self test function applies an electrostatic force to the MEMS structure that causes it to move in a manner that simulates its response to actual rotation. Set MSC_CTRL[10] = 1 (DIN = 0x9D04) to run the automatic self test routine, which reports a pass/fail result in DIAG_STAT[5]. MSC_CTRL[10] resets itself to 0 after completing this routine.

POWER MANAGEMENT

The SLP_CTRL register (see Table 33) provides two different sleep modes for system level management: normal and timed. Set SLP_CTRL[7:0] = 0xFF (DIN = 0xA4FF) to start normal sleep mode. To awaken the device from sleep mode, use one of the following options to restore normal operation: assert \overline{CS} from high to low; pulse \overline{RST} low, then high again; or cycle the power. Use SLP_CTRL[7:0] to put the device into sleep mode for a specified period. For example, SLP_CTRL[7:0] = 0x64 (DIN = 0xA464) puts the ADIS16137 to sleep for 50 sec.

Table 33. SLP_CTRL Bit Descriptions

Bits	Description
[15:8]	Not used
[7:0]	0xFF: normal sleep mode 0x00 to 0xFE: programmable sleep time bits; 0.5 sec/LSB

STATUS

The DIAG_STAT register (see Table 34) provides error flags for a number of functions. Each flag uses a 1 to indicate an error condition and a 0 to indicate a normal condition. Reading this register provides access to the status of each flag and resets all of the bits to 0 for monitoring future operation. If the error condition remains, the error flag returns to 1 at the conclusion of the next sample cycle. The SPI communication error flag in DIAG_STAT[3] indicates that the number of SCLKs in a SPI sequence did not equal a multiple of 16 SCLKs.

Table 34. DIAG_STAT Bit Descriptions

Bits	Description (Default = 0x0000)
[15:10]	Not used
9	Alarm 2 status (1 = active, 0 = inactive)
8	Alarm 1 status (1 = active, 0 = inactive)
7	Not used
6	Flash test, checksum flag (1 = fail, 0 = pass)
5	Self test diagnostic error flag (1 = fail, 0 = pass)
4	Sensor over range (1 = overrange, 0 = normal)
3	SPI communication failure (1 = fail, 0 = pass)
2	Flash update failure (1 = fail, 0 = pass)
[1:0]	Not used

PRODUCT IDENTIFICATION

The PROD_ID register (see Table 35) contains 0x3F09, which is the hexadecimal equivalent of 16,137. The LOT_ID1, LOT_ID2, and LOT_ID3 registers (see Table 36) provide manufacturing lot information. The SERIAL_NUM register (see Table 37) contains a binary number that represents the serial number on the device label and is lot specific.

Table 35. PROD_ID Bit Descriptions

Bits	Description (Default = 0x3F09)
[15:0]	Product identification = 0x3F09 (16,137)

Table 36. LOT_ID1, LOT_ID2, LOT_ID3 Bit Descriptions

Bits	Description
[15:0]	Lot identification, binary code

Table 37. SERIAL_NUM Bit Descriptions

Bits	Description
[15:14]	Not used
[13:0]	Serial number, 1 to 9999 (0x270F)

APPLICATIONS INFORMATION

POWER SUPPLY CONSIDERATIONS

The ADIS16137 includes 12 μF of capacitance across the VDD and GND pins. This capacitance presents low input impedance for power supplies that have fast rise times. The internal power regulator waits for a valid input supply voltage before initiating a start-up process that draws an elevated current ($\sim 400\text{ mA}$) for approximately 1.5 ms. This transient current occurs approximately 125 ms after VDD reaches a valid level. This regulation circuit also provides a constant power load, which results in a load that has a negative dynamic resistance. Figure 21 provides a graphical relationship between the supply current and voltage for systems that need to account for this type of load when designing supply feedback loops.

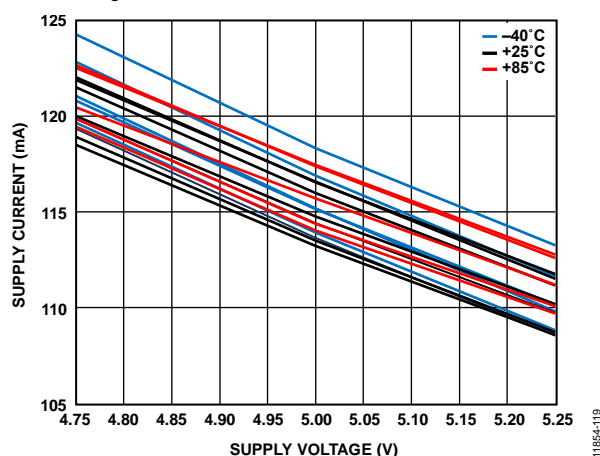


Figure 21. Supply Current vs. Supply Voltage

PROTOTYPE INTERFACE BOARD

The ADIS16IMU1/PCBZ (sold separately) provides a breakout board function for the ADIS16137BMLZ. This interface PCB provides larger connectors than the ADIS16137BMLZ, which results in a simpler connection with a SPI-compatible processor board. It also provides four tapped M2 holes for attachment of the ADIS16137BMLZ to the breakout board and four holes (machine screw size M2.5 or No. 4) for mounting the breakout board to a solid structure. J1 is a dual row, 2 mm (pitch) connector that works with 1 mm ribbon cable systems.

Figure 22 provides the top level view of the interface board. Install the ADIS16137BMLZ onto this board using the silk pattern as an orientation guide. Figure 23 provides the pin assignments for J1 that match the ADIS16137BMLZ pin functions, which are listed in Table 5. The ADIS16137 does not require external capacitors for normal operation; therefore, the interface PCB does not use the C1 and C2 pads.

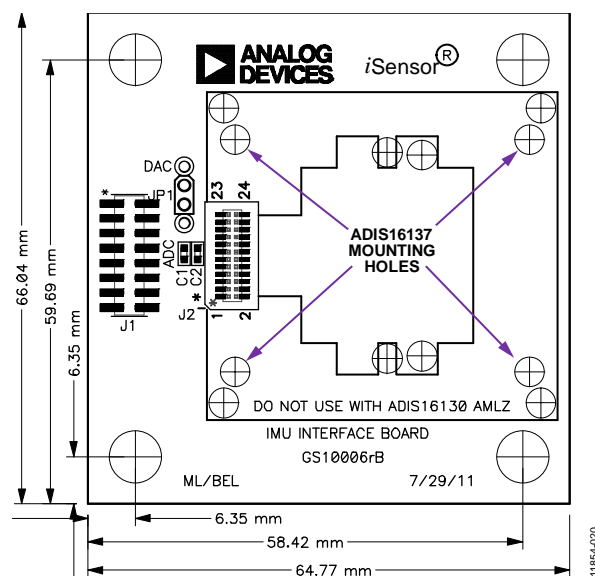


Figure 22. Physical Diagram for the ADIS16IMU1/PCBZ

J1			
RST	1	2	SCLK
CS	3	4	DOUT
DNC	5	6	DIN
GND	7	8	GND
GND	9	10	VDD
VDD	11	12	VDD
DIO1	13	14	DIO2
DIO3	15	16	DIO4/CLKIN

Figure 23. J1 Pin Assignments

INSTALLATION TIPS

Figure 24 and Figure 25 provide the mechanical design information for the ADIS161MU1/PCBZ. Use these figures when implementing a connector down approach, where the mating connector and the ADIS16137BMLZ are on the same surface. When designing a connector up system, use the mounting holes shown in Figure 24 as a guide in designing the bulkhead mounting system and use Figure 25 as a guide in developing the mating connector interface on a flexible circuit or other connector system. The mating connector pattern in Figure 25 assumes the use of the Samtec CLM-112-02 series of connectors.

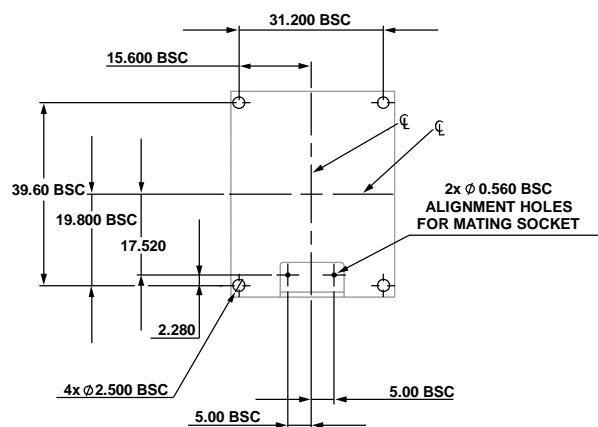


Figure 24. Suggested Mounting Hole Locations, Connector Down

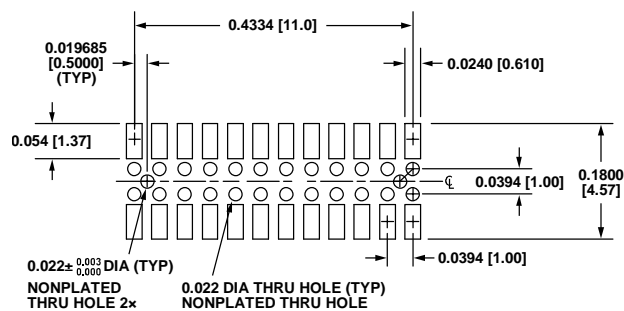


Figure 25. Suggested Layout and Mechanical Design for the Mating Connector

11864-022

11864-023

PACKAGING AND ORDERING INFORMATION

OUTLINE DIMENSIONS

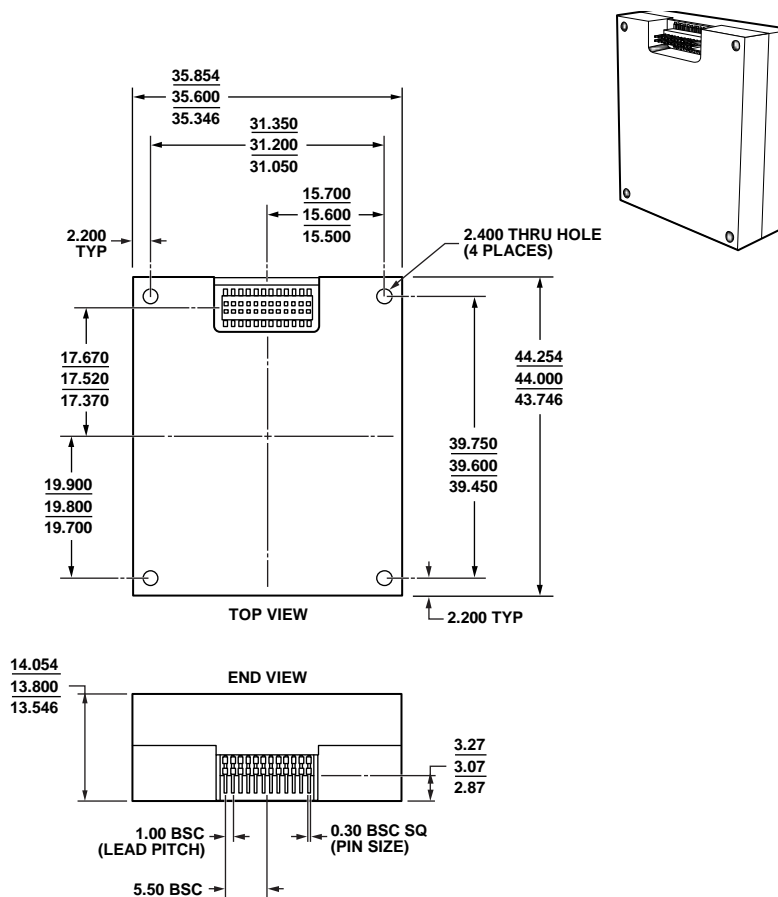


Figure 26. 24-Lead Module with Connector Interface
(ML-24-3)
Dimensions shown in millimeters

010508-A

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
ADIS16137BMLZ	-40°C to +105°C	24-Lead Module with Connector Interface	ML-24-3

¹ Z = RoHS Compliant Part.

NOTES